

# **RX Family**

# LPC Module Using Firmware Integration Technology

#### Introduction

The RX Family has a variety of options that allow the user to conserve power. This FIT-compliant module provides an API that allows the user to easily configure the RX Family CPUs into their various low power consumption modes and operating power control modes. The module also supports Sleep mode Return Clock Switching. This application note describes the Low Power Consumption (LPC) module API including usage examples.

# **Target Device**

The following is a list of devices that are currently supported by this API:

- RX110, RX111, RX113 Groups
- RX130 Group
- RX140 Group
- RX230, RX231 Groups
- RX23W Group
- RX64M Group
- RX65N Group
- RX66N Group
- RX671 Group
- RX71M Group
- RX72M Group
- RX72N Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

# **Target Compilers**

- Renesas Electronics C/C++ Compiler Package for RX Family
- · GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to "5.1 Confirmed Operation Environment".



# **Contents**

1.	Overview	3
1.1	LPC FIT Module	3
1.2	Overview of the LPC FIT Module	3
1.3	API Overview	4
1.4	State Transition Diagram	5
2.	API Information	8
2.1	Hardware Requirements	8
2.2	Software Requirements	8
2.3	Supported Toolchains	8
2.4	Interrupt Vector	8
2.5	Header Files	8
2.6	Integer Types	8
2.7	Configuration Overview	9
2.8	Code Size	10
2.9	Parameters	11
2.9.1	R_LPC_OperatingModeSet Data Types	11
2.9.2	2 R_LPC_LowPowerModeConfigure Data Types	11
2.9.3	R_LPC_ReturnClockSwitch Data Types	12
2.9.4	R_LPC_SnoozeModeConfigure Data Types	12
2.10	Return Values	12
2.11	Callback Function	13
2.12	Adding the FIT Module to Your Project	14
2.13	"for", "while" and "do while" statements	15
3.	API Functions	16
3.1	R_LPC_OperatingModeSet ()	16
3.2	R_LPC_LowPowerModeConfigure ()	18
3.3	R_LPC_LowPowerModeActivate ()	19
3.4	R_LPC_SnoozeModeConfigure ()	23
3.5	R_LPC_ReturnClockSwitch ()	27
3.6	R_LPC_GetVersion ()	28
4.	Usage Examples	29
4.1	Example sequence for entering higher power operating modes, RX1xx MCUs	29
4.2	Example sequence for entering lower power operating modes, RX1xx MCUs	30
5.	Appendices	31
5.1	Confirmed Operation Environment	31
5.2	Troubleshooting	34
Revi	ision History	35

#### 1. Overview

#### 1.1 LPC FIT Module

The LPC FIT module can be used by being implemented in a project as an API. See section 2.12 Adding the FIT Module to Your Project for details on methods to implement this FIT module into a project.

#### 1.2 Overview of the LPC FIT Module

The operating power control modes for the supported RX CPUs are given in the following table:

**Table 1.1 Operating Power Control modes** 

Supported Operating Power Control modes			
RX110, RX111, RX113, RX130, RX230, RX231, RX23W	RX140	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N	
High Speed	High Speed	High Speed	
Middle Speed	Middle Speed	Low Speed 1	
Low Speed	Middle Speed 2 Low Speed	Low Speed 2	

Each of the operating power control modes has upper and lower limits on the Vcc requirements and the maximum internal clock frequencies supported.

For the RX110, RX111, RX113, for example in High Speed Mode, all the internal clocks can be configured for the system maximum of 32 MHz (when  $3.6V > Vcc \ge 2.7$ ) whereas in Middle Speed Mode, the maximum speeds are limited to 12 MHz (when  $3.6V > Vcc \ge 2.4$ ). In the Low Speed Mode, only the Sub-Clock can be used as the system clock and all internal clocks are limited to a maximum of 32.768 kHz.

The voltage-frequency requirements vary across the RX Family and individual requirements can be found in the specific hardware manual.

In addition to the "Operating" Power Control modes, several Low Power Consumption modes also exist where the CPU is inactive (not operating), namely:

**Table 1.2: Low Power Consumption modes** 

Supported Low Power Consumption modes				
RX110, RX111, RX113, RX130, RX140 RX64M, RX65N, RX66N, RX671, RX230, RX231, RX23W RX71M, RX72M, RX72N				
Sleep Deep Sleep Software Standby	Sleep Deep Sleep Software Standby Snooze	Sleep All-Module Clock Stop Software Standby Deep Software Standby		

In each of these modes, certain peripherals are limited or disabled.



# 1.3 API Overview

Table 1.3 lists the API functions included in this module.

Table 1.3 API Functions

Function	Description
R_LPC_OperatingModeSet	Configures the MCU for the different supported Operating Power Control modes. See Table 1.1 Operating Power Control modes
R_LPC_LowPowerModeConfigure	Configures the MCU for the different Low Power Consumption modes. See Table 1.2: Low Power Consumption modes
R_LPC_LowPowerModeActivate	Enables the Low Power Mode configured by R_LPC_LowPowerModeConfigure()
R_LPC_SnoozeModeConfigure	Select the conditions for transition to the snooze mode, return to the software standby mode, or release from the snooze mode.
R_LPC_ReturnClockSwitch	Configures Sleep mode return clock switching
R_LPC_GetVersion	Returns at runtime the driver version number.

# 1.4 State Transition Diagram

Figure 1-1, Figure 1-2 and Figure 1-3 shows the state transition diagram for this module.

The following charts show a high level view of the Operating Power Control modes and Low Power Consumption modes as well as the LPC API calls that allow for switching between the modes.

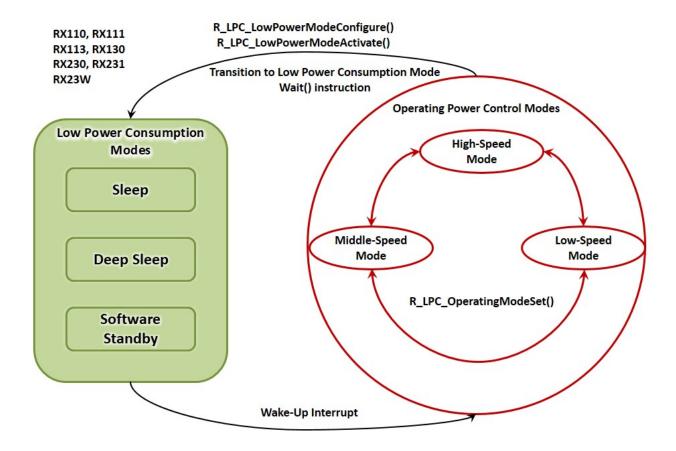


Figure 1-1 LPC API Overview(RX110, RX111, RX113, RX130, RX230, RX231, RX23W)

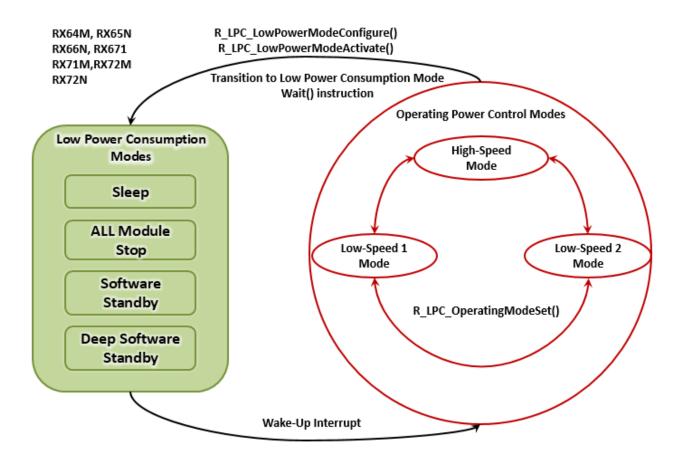


Figure 1-2 LPC API Overview(RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N)

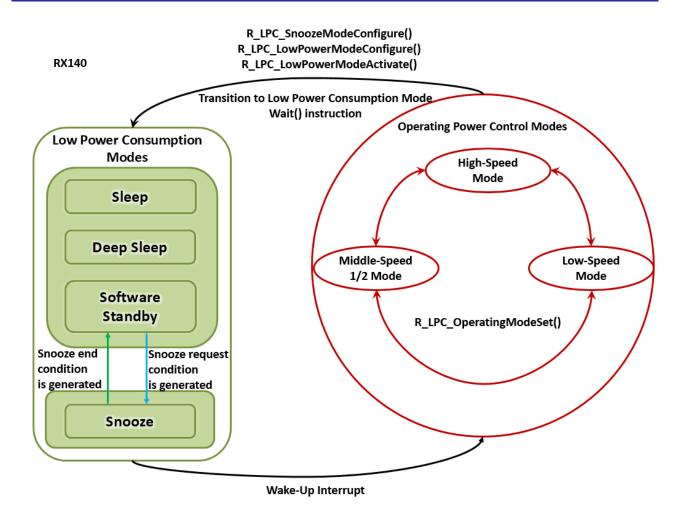


Figure 1-3 LPC API Overview(RX140)

#### 2. API Information

This FIT module has been confirmed to operate under the following conditions.

# 2.1 Hardware Requirements

The MCU used must support the following functions:

- Switching the Operating Power Control Modes given in <u>Table1 in section 1</u>:
- Switching Low Power Consumption Modes given in <u>Table2 in section 1</u>:

# 2.2 Software Requirements

This driver is dependent upon the following FIT module:

Renesas Board Support Package (r\_bsp) v5.20 or higher

# 2.3 Supported Toolchains

This driver has been confirmed to work with the toolchain listed in 5.1, Confirmed Operation Environment.

# 2.4 Interrupt Vector

Executing the R\_LPC\_SnoozeModeConfigure function will enable the snooze release interrupt according to the parameter setting.

Table 2-1 list the interrupt vector used in the FIT Module.

#### **Table 2-1 Interrupt Vector**

Device	Interrupt Vector
RX140	Snooze release interrupt (vector number: 81)

#### 2.5 Header Files

All API calls and their supporting interface definitions are located in "r\_lpc\_rx\_if.h".

# 2.6 Integer Types

This project uses ANSI C99. These types are defined in stdint.h.



# 2.7 Configuration Overview

The configuration option settings of this module are located in "r\_lpc\_rx\_config.h". The option names and setting values are listed in the table below:

Table 2-2: Info about the configuration

Configuration options in r_lpc_rx_config.h				
#define	Default Value	Description		
LPC_CFG_PARAM_CHECKING_ENABLE	1	If this equate is set to 1, parameter checking is included in the build. If the equate is set to 0, the parameter checking is omitted from the build. Setting this equate to BSP_CFG_PARAM_CHECKING_ENABLE utilizes the system default setting.		

### 2.8 Code Size

The sizes of ROM, RAM and maximum stack usage associated with this module are listed below. Information is listed for a single representative device of the RX100 Series, RX200 Series and RX600 Series, respectively.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.7, Configuration Overview.

The values in the table below are confirmed under the following conditions.

Module Revision: r\_lpc\_rx rev2.03

Compiler Version: Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00

(The option of "-lang = c99" is added to the default settings of the integrated development environment.)

development environment.)

GCC for Renesas RX 8.3.0.202102

(The option of "-std=gnu99" is added to the default settings of the integrated development environment.)

IAR C/C++ Compiler for Renesas RX version 4.20.1

(The default settings of the integrated development environment.)

Configuration Options: Default settings

	ROM, RAM and Stack Code Sizes						
Device	Category	Memory Used					
		Renesas Compiler		GCC		IAR Compiler	
		With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking
RX130	ROM (Note 1)	9002 bytes	7092 bytes	14940 bytes	11612 bytes	8517 bytes	6429 bytes
	RAM (Note 1)	3194 bytes	3154 bytes	3012 bytes	2972 bytes	1718 bytes	1678 bytes
	STACK (Note 2)	76 bytes		-		116 bytes	
RX231	ROM (Note 1)	8287 bytes	7434 bytes	13988 bytes	12324 bytes	8076 bytes	6859 bytes
	RAM (Note 1)	7134 bytes	7094 bytes	6952 bytes	6912 bytes	1818 bytes	1778 bytes
	STACK (Note 2)	56 bytes		-		116 bytes	
RX64M	ROM (Note 1)	10699 bytes	9820 bytes	19132 bytes	17420 bytes	12110 bytes	10891 bytes
	RAM (Note 1)	7752 bytes	7712 bytes	7568 bytes	7528 bytes	2436 bytes	2396 bytes
	STACK (Note 2)	72 bytes		-		124 bytes	

Note 1: The above ROM or RAM size includes ROM / RAM size of BSP FIT module.

Note 2: The above STACK size doesn't include stack size of BSP FIT module.

#### 2.9 Parameters

This section describes the parameter structure used by the API functions in this module. The enumeration type is located in r\_lpc\_[device]\_if.h(ex: r\_lpc\_rx64m\_if.h) as are the prototype declarations of API functions.

# 2.9.1 R\_LPC\_OperatingModeSet Data Types

```
/* Operating power control modes for RX110, RX111, RX113, RX130, RX230, RX231,
typedef enum lpc_operating_mode
    LPC OP HIGH SPEED = 0 \times 00,
   LPC OP MIDDLE SPEED = 0 \times 02,
   LPC_OP_LOW_SPEED
                      = 0x06,
   LPC_OP_INVALID_MODE
} lpc_operating_mode_t;
/* Operating power control modes for RX64M, RX65N, RX66N, RX671, RX71M, RX72M,
RX72N */
typedef enum lpc_operating_mode{
                        = 0x00,
   LPC_OP_HIGH_SPEED
   LPC_OP_LOW_SPEED_1
                          = 0 \times 06,
                        = 0x07,
   LPC_OP_LOW_SPEED_2
    LPC_OP_INVALID_MODE
} lpc_operating_mode_t;
/* Operating power control modes for RX140 */
typedef enum lpc_operating_mode
    LPC_OP_HIGH_SPEED = 0x00,
    LPC_OP_MIDDLE_SPEED = 0x02
    LPC_OP_MIDDLE_SPEED_2 = 0x04,
    LPC_OP_LOW_SPEED = 0x06,
    LPC_OP_INVALID_MODE
}lpc_operating_mode_t;
```

# 2.9.2 R\_LPC\_LowPowerModeConfigure Data Types

```
/* Low Power Modes for RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W */
typedef enum lpc_low_power_mode
{
    LPC_LP_SLEEP,
    LPC_LP_DEEP_SLEEP,
    LPC_LP_INVALID_MODE
} lpc_low_power_mode_t;

/* Low Power Modes for RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N */
typedef enum lpc_low_power_mode{
    LPC_LP_SLEEP,
    LPC_LP_SLEEP,
    LPC_LP_ALL_MODULE_STOP,
    LPC_LP_SW_STANDBY,
    LPC_LP_DEEP_SW_STANDBY,
    LPC_LP_INVALID_MODE
} lpc_low_power_mode_t;
```

#### 2.9.3 R\_LPC\_ReturnClockSwitch Data Types

#### 2.9.4 R\_LPC\_SnoozeModeConfigure Data Types

```
/* Conditions for transition to snooze mode, return to software standby mode,
and snooze mode release interrupt for RX140 */
typedef struct st_lpc_snooze_mode
{
    uint16_t snooze_operation;
    uint16_t snooze_release;
    lpc_snooze_interrupt_t snooze_interrupt;
} lpc_snooze_mode_t;

typedef struct st_lpc_snooze_interrupt
{
    uint8_t priority;
    lpc_snooze_callback_set_t pcallback;
} lpc_snooze_interrupt_t;
```

#### 2.10 Return Values

This describes the parameter structure used by the API functions in this module. The enumeration type is located in r\_lpc\_rx\_if.h as are the prototype declarations of API functions.

```
/* LPC API error codes */
typedef enum lpc_err
  LPC_SUCCESS,
 LPC_ERR_OSC_STOP_ENABLED, // Software Standby cannot be entered if osc stop is enabled.
 LPC_ERR_CLOCK_EXCEEDED,
                           // Clock exceeds the limit of the operating power control
                           // mode.
 LPC_ERR_ILL_MAIN_CLK_FREQ,// Clock freq. exceeds the limit of the sleep return clock.
 LPC_ERR_ILL_CLOCK_SOURCE, // Illegal clock when sleep mode return clock switching
                            // is enabled
 LPC_ERR_P_E_MODE,
                           // The operating power control mode cannot be switched while
                           // the flash memory is being programmed or erased (P/E).
 LPC_ERR_DEEP_SLEEP_STATUS,// The condition error for a deep sleep mode.
 LPC_ERR_ILL_PARAM // (Not used)
                          // Illegal operation
 LPC_ERR_ILLEGAL
} lpc_err_t;
```

# 2.11 Callback Function

In this module, the callback function set by the user is called at the timing explained below. Callback functions are set in each function.

- 1. Call the callback function before transitioning to the low power state.
  - For details, refer to "R\_LPC\_LowPowerModeActivate ()" in "3 API Functions".
- 2. Call the callback function when the snooze release interrupt occurs.
  - For details, refer to "R\_LPC\_SnoozeModeConfigure ()" in "3 API Functions".

# 2.12 Adding the FIT Module to Your Project

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (3) or (5) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) or (4) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e<sup>2</sup> studio
  By using the Smart Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project.
  Refer to "RX Smart Configurator User's Guide: e<sup>2</sup> studio (R20AN0451)" for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e<sup>2</sup> studio
  By using the FIT Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project.
  Refer to "RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723)" for details.
- (3) Adding the FIT module to your project using the Smart Configurator in CS+
  By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: CS+ (R20AN0470)" for details.
- (4) Adding the FIT module to your project in CS+ In CS+, please manually add the FIT module to your project. Refer to "RX Family Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)" for details.
- (5) Adding the FIT module to your project using the Smart Configurator in IAREW By using the Smart Configurator Standalone version, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: IAREW (R20AN0535)" for details.

# 2.13 "for", "while" and "do while" statements

In this module, "for", "while" and "do while" statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with "WAIT\_LOOP" as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with "WAIT\_LOOP".

The following shows example of description.

```
while statement example :
/* WAIT_LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}

for statement example :
/* Initialize reference counters to 0. */
/* WAIT_LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)
{
    g_protect_counters[i] = 0;
}

do while statement example :
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */</pre>
```

#### 3. API Functions

# 3.1 R\_LPC\_OperatingModeSet ()

This function configures the MCU for the supported Operating Power Control modes (See Table 1.1 Operating Power Control modes

).

#### **Format**

```
lpc_err_t R_LPC_OperatingModeSet(
    lpc_operating_mode_t e_mode
)
```

#### **Parameters**

lpc\_operating\_mode\_t e\_mode

The modes for all supported MCUs are specified in enum *lpc operating mode t* in section 2.9.1.

#### **Return Values**

LPC SUCCESS:

LPC\_ERR\_CLOCK\_EXCEEDED: // Clock exceeds the limit of the operating power control mode.

LPC\_ERR\_P\_E\_MODE: // The operating power control mode cannot be switched while // the flash memory is being programmed or erased (P/E).

#### **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

#### **Description**

Depending upon the mode chosen and the MCU, the maximum speed of the internal clocks ICLK, PCLKB, PCLKD and FCLK is limited. For example, in Low-Speed operating mode on the RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W, only the sub-clock can be used as the system clock. See Table 11.3 (RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N) and Table 11.4 (RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W) in the Hardware manual for clock limitations. If the argument to this function cannot support the current internal clock frequencies, then an error is returned. When switching the clock source from a lower frequency to a higher frequency, make certain that the operating power control mode is configured to support the range. Failure to do so will result in improper CPU operation.

# **Example**

```
lpc_err_t err;
err = R_LPC_OperatingModeSet(LPC_OP_MIDDLE_SPEED);
```

### **Special Notes:**

When switching operating power control modes and internal clock frequencies, it is important to first make sure that the frequencies of internal clocks are set within the range supported by the operating power control mode. When moving between operating power control modes/frequencies, use the following sequence:

- 1. Moving from low power and low internal frequencies to higher power and higher clock frequencies:
  - a. Use R\_LPC\_OperatingModeSet() to move to higher power operating mode.
  - b. Increase internal clock frequencies
- 2. Moving from high power and high internal clock frequencies to low power and low internal frequencies:
  - a. Decrease internal clock frequencies
  - b. Use R\_LPC\_OperatingModeSet() to move to lower power operating mode.



# 3.2 R\_LPC\_LowPowerModeConfigure ()

This function configures the low power consumption modes (see <u>Table 1.2: Low Power Consumption modes</u>) when the WAIT instruction is executed.

#### **Format**

```
lpc_err_t     R_LPC_LowPowerModeConfigure(
     lpc_low_power_mode_t e_mode
)
```

#### **Parameters**

lpc\_low\_power\_mode\_t e\_mode

The modes for all supported MCUs are specified in enum <a href="mailto:localize-local-power\_mode\_t">local-power\_mode\_t</a>.

#### **Return Values**

LPC\_SUCCESS:

#### **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

## **Description**

This function configures the MCU for the different Low Power Consumption modes shown in <u>Table 1.2: Low Power Consumption modes</u>

. Note that this function does not activate the low power mode, but configures the registers for the specified mode. To activate the low power mode, use the R\_LPC\_LowPowerModeActivate() function.

The CPU will be stopped once any of these modes are activated; however a few of the peripherals and clocks can operate in these modes. For more details refer to the User's Manual: Hardware.

## **Special Notes:**

None



# 3.3 R\_LPC\_LowPowerModeActivate ()

This function activates the Low Power Consumption mode configured in R\_LPC\_LowPowerModeConfigure ().

#### **Format**

```
lpc_err_t R_LPC_LowPowerModeActivate(
    void (*pcallback)(void* pdata)
)
```

#### **Parameters**

void (\*pcallback)(void\* pdata)

Function to be called before activating low power mode.

#### **Return Values**

```
LPC_SUCCESS:
```

```
LPC_ERR_OSC_STOP_ENABLED: // Cannot enter software standby if oscillation stop detection // is enabled.

LPC_ERR_ILL_CLOCK_SOURCE: // Illegal clock when sleep mode return clock switching is enabled LPC_ERR_ILL_MAIN_CLK_FREQ: // Clock freq. exceeds the limit of the sleep return clock. LPC_ERR_DEEP_SLEEP_STATUS:// The condition error for a deep sleep mode LPC_ERR_ILLEGAL // Illegal operation other than above
```

#### **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

#### **Description**

This function activates the low power mode by calling the wait() function. The hardware manual specifies the sequence for entering low power mode as follows:

- 1. Disable interrupts.
- 2. Configure the interrupt source to wake the MCU up from the low power mode.
- 3. Ensure that the last IO register write is successful.
- 4. Execute the wait instruction to enter the low power mode. The wait instruction will internally enable interrupts.

This function implements the sequence as follows:

- 1. Disable interrupts.
- 2. Call the callback function specified by the argument. The callback function should configure the wake-up interrupt source and make sure that the last IO register write is complete before returning. The user can pass a FIT\_NO\_FUNC pointer if the interrupt has already been configured.
- 3. Execute the wait instruction.



When this function is executed, an error is returned under the following conditions.

Table 3.1: Limitations and Return Values when Entering Sleep Mode

Limitation	Return Value on an Error	CPU
When sleep mode return clock switching is enabled, the sub-clock must be selected.	LPC_ERR_ILL_CLOCK_SOURCE	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W
When sleep mode return clock switching is enabled, the system clock or the subclock must be selected.	LPC_ERR_ILL_CLOCK_SOURCE	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
When the operating power control mode after returning from sleep mode is middle speed mode, HOCO cannot be selected as the return clock.	LPC_ERR_ILL_CLOCK_SOURCE	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W
When the operating power control mode after returning from sleep mode is middle speed mode, and the main clock is selected as the sleep mode return clock, the internal clock must be set to comply with the limitation of the middle speed mode.	LPC_ERR_ILL_MAIN_CLK_FREQ	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W
When HOCO is selected as the sleep mode return clock, HOCO must be powered on.	LPC_ERR_ILL_CLOCK_SOURCE	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N

Table 3.2: Limitations and Return Values when Entering All-Module Clock Stop Mode

Limitation	Return Value on an Error	CPU
The module stop control register must be specified to meet the conditions of all-module clock stop mode.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
All-module clock stop mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N

Table 3.3: Limitations and Return Values when Entering Deep Sleep Mode

Limitation	Return Value on an Error	CPU
The MSTPCRA.MSTPA28 bit must be set to 1 (transition to the module-stop state for DMAC/DTC is made) before entering deep sleep mode.	LPC_ERR_DEEP_SLEEP_STATUS	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W
Deep sleep mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W

Table 3.4: Limitations and Return Values when Entering Software Standby Mode

Limitation	Return Value on an Error	CPU
When the oscillation stop detection function is enabled, software standby mode cannot be entered.	LPC_ERR_OSC_STOP_ENABLED	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W, RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
Enter software standby mode while the DMAST.DMST bit is 0.	LPC_ERR_ILLEGAL	RX230, RX231, RX23W, RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
Enter software standby mode while the DTCST.DTCST bit is 0.	LPC_ERR_ILLEGAL	RX110, RX111, RX113, RX130, RX140*1, RX230, RX231, RX23W, RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
Software standby mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX110, RX111, RX113, RX130, RX140, RX230, RX231, RX23W, RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N

Note 1:Except when using DTC in snooze mode on the RX140.

Table 3.5: Limitations and Return Values when Entering Deep Software Standby Mode

Limitation	Return Value on an Error	CPU
When the oscillation stop detection function is enabled, deep software standby mode cannot be entered.	LPC_ERR_OSC_STOP_ENABLED	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
Enter deep software standby mode while the DMAST.DMST bit is 0.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
Enter deep software standby mode while the DTCST.DTCST bit is 0.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
Deep software standby mode cannot be entered during flash memory P/E mode.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
When using IWDT with auto-start mode, deep software standby mode cannot be entered if the OFS0.IWDTSLCSTP bit is 0 (counting stop is disabled).	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
When using IWDT with register start mode, deep software standby mode cannot be entered if the IWDTCSTPR.SLCSTP bit is 0.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N
When voltage monitoring 1 reset is enabled (LVD1CR0.LVD1RI = 1) or voltage monitoring 2 reset is enabled (LVD2CR0.LVD2RI = 1) in the voltage detection circuit, deep software standby mode is not entered.	LPC_ERR_ILLEGAL	RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N

#### Example

```
lpc_err_t err;

err = R_LPC_LowPowerModeConfigure (LPC_LP_SLEEP);

err = R_LPC_LowPowerModeActivate(FIT_NO_FUNC);
```

#### **Special Notes:**

When parameter checking is enabled for the module, this function checks for a variety of conditions that prevent the MCU from entering a low power mode. While it is important to have this feature enabled in the development phase, it can be disabled during release to allow for a more rapid entry into low power modes.

Before entering Deep Sleep or Software Standby mode, ensure that DTC transactions are not pending and the DTC module is stopped.

# 3.4 R\_LPC\_SnoozeModeConfigure ()

This function sets the conditions for entering the snooze mode, returning to the software standby mode, or releasing the interrupt source of the snooze mode.

#### **Format**

```
lpc_err_t R_LPC_SnoozeModeConfigure(
  lpc_snooze_mode_t * snooze_mode
)
```

#### **Parameters**

```
lpc_snooze_mode_t * snooze_mode
```

snooze\_mode->snooze\_operation

Select the conditions for entering snooze mode and returning to software standby mode.

See Table 3.6: parameter description (snooze operation).

snooze mode->snooze release

Select the interrupt source to be released from the snooze mode.

See Table 3.7: parameter description (snooze release).

```
snooze_mode->snooze_interrupt
```

Sets the interrupt priority level and callback function for the snooze release interrupt.

See Table 3.8: Parameter description (snooze\_interrupt).

#### **Return Values**

LPC\_SUCCESS LPC\_ERR\_ILLEGAL

#### **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

### **Description**

This function sets the conditions for entering the snooze mode, returning to the software standby mode or releasing from the snooze mode.

When using the snooze release interrupt to release snooze mode, set the conditions for the snooze release interrupt, and set the interrupt priority level and callback function. If you do not want to use the snooze release interrupt, set LPC\_SNZ\_RESET in the snooze release interrupt condition (snooze\_release). Setting LPC\_SNZ\_RESET disables the snooze release interrupt and ignores the interrupt priority level and callback function settings.

For the peripheral functions that can be operated in snooze mode, refer to the user's Hardware manual See Tables **Table 3.6** to **Table 3.8** for parameter settings. This function can only be used on devices that have snooze mode.

Table 3.6: parameter description (snooze\_operation)

Macro	define	description
LPC_SNZ_RESET	(0x0000)	Initialize the setting information.
LPC_SNZ_SCI5_REQ_EXIT	(0x0002)	SCI5 is placed in the snooze mode on detection of the falling edge of RXD5. It is placed back in the software standby mode when the received data do not match the value of the CDR register of SCI5.
LPC_SNZ_SCI5_DTC_REQ_EXIT	(0x0003)	SCI5 is placed in the snooze mode on detection of the falling edge of RXD5. It is placed back in the software standby mode when the received data do not match

		the value of the CDR register of SCI5, or once transfer of the received data by the DTC has been completed.
LPC_SNZ_LPT_REQ	(0x0008)	The LPT is placed in the snooze mode in response to the LPT compare match 1, and will not be placed back in the software standby mode, but remains in the snooze mode.
LPC_SNZ_LPT_DTC_REQ_EXIT	(0x000c)	The LPT is placed in the snooze mode in response to the LPT compare match 1, and will be placed back in the software standby mode once a single round of the DTC transfer triggered by the LPT compare match 1 has been completed.
LPC_SNZ_S12AD_REQ	(0x0020)	The S12AD is placed in the snooze mode in response to the LPT compare match 1, and perform A/D conversion, and will not be placed back in the software standby mode, but remains in the snooze mode.
LPC_SNZ_S12AD_DTC_REQ_EXIT	(0x0030)	The S12AD is placed in the snooze mode in response to the LPT compare match 1, and perform A/D conversion, and will be placed back in the software standby mode once a single round of the DTC transfer triggered by the end of A/D conversion has been completed.
LPC_SNZ_CTSU_REQ_EXIT	(0x0080)	The CTSU is placed in the snooze mode in response to the LPT compare match 1, and the measurement operation of the CTSU is started, and will be placed back in the software standby mode on request of the end of the snooze mode.
LPC_SNZ_DTC_ENABLE	(0x8000)	The DTC transfer is enabled in the snooze mode.

Table 3.7: parameter description (snooze\_release)

Macro	define	description
LPC_SNZ_RESET	(0x0000)	Initialize the setting information.
LPC_SNZ_SCI5_ERROR_RELEASE	(0x0001)	The SCI5 reception error is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_SCI5_FULL_RELEASE	(0x0004)	The SCI5 reception data full is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_SCI5_DTC_RELEASE	(0x0008)	The DTC transfer completion event in response to the SCI5 reception data full is selected for the interrupt of release from the snooze mode.
LPC_SNZ_LPT_MATCH1_RELEASE	(0x0010)	The LPT compare match 1 is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_LPT_DTC_RELEASE	(0x0020)	The DTC transfer completion event in response to the LPT compare match 1 is selected for the interrupt of release from the snooze mode.
LPC_SNZ_S12AD_RELEASE	(0x0040)	The completion of the S12AD conversion is selected as a source for the interrupt of release from the snooze mode.
LPC_SNZ_S12AD_DTC_RELEASE	(0x0080)	The DTC transfer completion event in response to the completion of the S12AD conversion is selected for

		the interrupt of release from the snooze mode.
LPC_SNZ_CTSU_RELEASE	(0x0100)	The completion of the CTSU measurement is selected as a source for the interrupt of release from the snooze mode.

Table 3.8 Parameter description (snooze\_interrupt)

data structure	Set value	description	
priority	type : uint8_t Set value : 0~15	Sets the interrupt priority level for snooze release interrupts. If you do not use the snooze release interrupt, the setting is ignored.	
pcallback	type: lpc_snooze_callback_set_t Set value: Function pointer	Sets the callback function for the snooze release interrupt. Set FIT_NO_FUNC if you do not want to use the callback function in the snooze release interrupt. If you do not use the snooze release interrupt, the setting is ignored.	

#### Example

Jul.31.21

```
lpc_err_t err;
lpc_snooze_mode_t snooze_mode;
/* When resetting the snooze mode setting */
snooze_mode.snooze_operation = LPC_SNZ_RESET;
snooze_mode.snooze_release = LPC_SNZ_RESET;
snooze_mode.snooze_interrupt.priority = 0;
snooze_mode.snooze_interrupt.pcallback = FIT_NO_FUNC;
/* When the snooze mode ends (software standby transition) due to a mismatch in
the received data of SCI5, and the snooze mode is canceled when the received
data is full */
snooze_mode.snooze_operation = LPC_SNZ_SCI5_REQ_EXIT;
snooze_mode.snooze_release = LPC_SNZ_SCI5_FULL_RELEASE;
snooze_mode.snooze_interrupt.priority = 5;
snooze_mode.snooze_interrupt.pcallback = FIT_NO_FUNC;
/* When the snooze mode ends (software standby transition) after DTC transfer of
received data of SCI5, and the snooze mode is canceled by DTC transfer end
interrupt */
snooze_mode.snooze_operation = LPC_SNZ_SCI5_DTC_REQ_EXIT | LPC_SNZ_DTC_ENABLE;
snooze_mode.snooze_release = LPC_SNZ_SCI5_DTC_RELEASE;
snooze_mode.snooze_interrupt.priority = 5;
snooze_mode.snooze_interrupt.pcallback
=(lpc_snooze_callback_set_t)&lpc_callback;
/* When using a callback function with a snooze release interrupt */
err = R_LPC_SnoozeModeConfigure (&snooze_mode);
err = R_LPC_LowPowerModeConfigure (LPC_LP_SW_STANDBY);
err = R_LPC_LowPowerModeActivate (FIT_NO_FUNC);
```

### **Special Notes:**

- In order to operate each peripheral function in snooze mode, the conditions for each peripheral function to be used must be satisfied before transitioning to software standby. For details, refer to the power consumption reduction function in the user's manual hardware.
- The snooze mode release interrupt condition is valid even in operation modes other than snooze
  mode. If you do not want to generate a snooze release interrupt in an operation mode other than the
  snooze mode, please use the settings to initialize the snooze mode to cancel the snooze mode
  before transitioning to software standby.



# 3.5 R\_LPC\_ReturnClockSwitch ()

This function configures the MCU to switch clock sources on waking up from Sleep mode.

#### **Format**

```
lpc_err_t R_LPC_ReturnClockSwitch(
    lpc_clock_switch_t e_clock_source,
    bool enable
)
```

#### **Parameters**

lpc\_clock\_switch\_t e\_clock\_source

This parameter selects the clock source to be used at the time of release from sleep mode. The supported clock sources are specified in the enum *lpc clock switch t* in section 2.9.3.

#### bool enable

Enables or disables clock source switching at the time of release from sleep mode. The clock source selected by e\_clock\_source is enabled only when enable = 1.

#### **Return Values**

LPC\_SUCCESS:

#### **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

#### **Description**

This function will configure the return clock switching parameter that allows the clock source to be switched on returning from Sleep Mode to the HOCO, LOCO or Main Clock. The following items have to be followed to allow for Return Clock Switching:

- 1. RX110, RX111, RX113 MCUs:
  - When entering Sleep Mode, the system clock should be the Sub-Clock oscillator. On exiting sleep, the operating mode will return to whatever the operating power control mode was before entering sleep.
  - If the Main OSC is chosen as the Sleep Return clock source, middle speed mode is the return mode. Make sure the internal clock after returning from sleep mode does not exceed the limits of middle speed mode.
- 2. RX130, RX140, RX230, RX231, RX23W MCUs:
  - When entering Sleep Mode, the system clock should be the Sub-Clock oscillator. On exiting sleep, the operating mode will return to whatever the operating power control mode was before entering sleep.
  - If Middle Speed mode is the return mode and the Main OSC is chosen as the Sleep Return clock source, make sure the internal clock after returning from sleep mode does not exceed the limits of middle speed mode.
- 3. RX64M, RX65N, RX66N, RX671, RX71M, RX72M, RX72N MCUs:

When entering sleep mode, select LOCO or the sub-clock as the clock source.

#### **Example**

```
lpc_err_t err;

err = R_LPC_ReturnClockSwitch(LPC_MAIN_OSC, true);
```

#### **Special Notes:**

None.



# 3.6 R\_LPC\_GetVersion ()

This function returns the driver version number at runtime.

#### **Format**

uint32\_t R\_LPC\_GetVersion(void);

#### **Parameters**

none

#### **Return Values**

Version number.

## **Properties**

Prototyped in file "r\_lpc\_rx\_if.h"

# **Description**

Returns the version of this module. The version number is encoded such that the top 2 bytes are the major version number and the bottom 2 bytes are the minor version number.

## **Example**

```
version = R_LPC_GetVersion();
```

# **Special Notes:**

None

# 4. Usage Examples

# 4.1 Example sequence for entering higher power operating modes, RX1xx MCUs

The RX110, RX111, RX113, RX130 MCUs have internal regulators that control power to the chip. Configuring the regulators to supply higher power before moving into a higher power state is necessary for proper operation.

Below is an example that shows the sequence of operations and API calls necessary to move from a lower power state to a higher powered one. It is assumed that at the start of this sequence, the system clock source is the sub-clock and the operating power control mode is Low Speed mode.

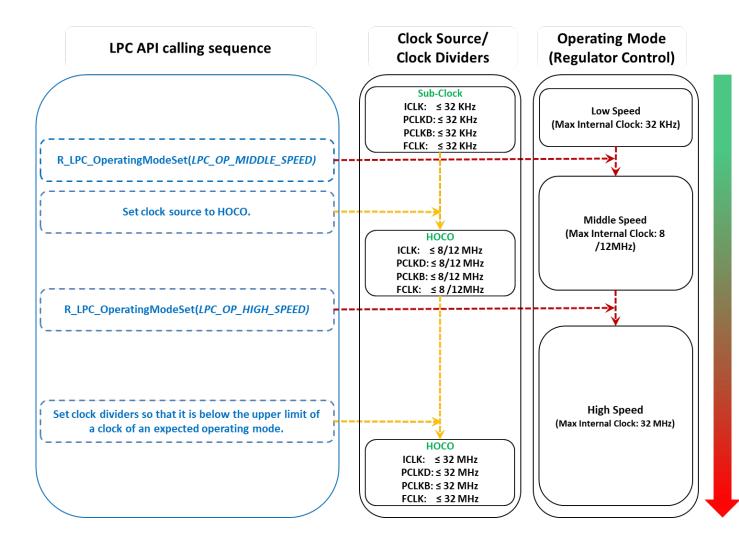


Figure 4-1: Sequence for moving from a low power to high power state (RX110, RX111, RX113, RX130)

# 4.2 Example sequence for entering lower power operating modes, RX1xx MCUs

When moving to lower power states, it is important to first move to the lower power state before switching the regulator down for lower supply voltage.

Below is an example that shows the sequence of operations and API calls necessary to move from a higher power state to a lower powered one. It is assumed that at the start of this sequence, the system clock source is the HOCO and the operating power control mode is High Speed mode.

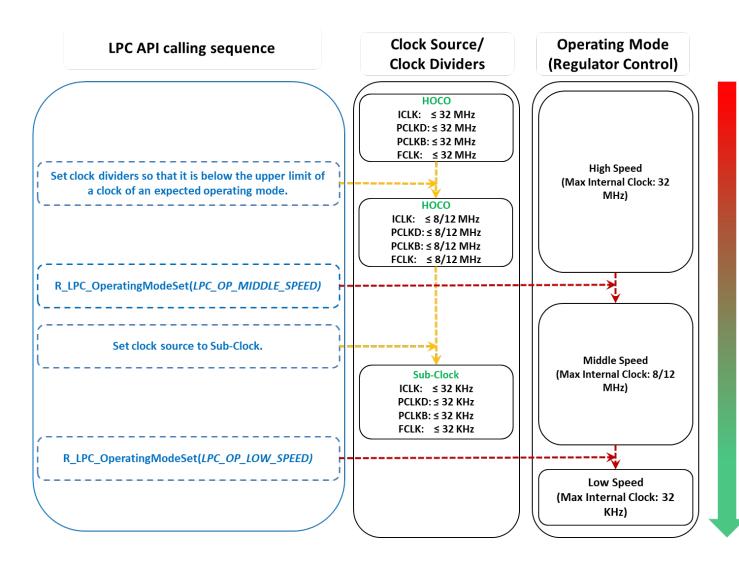


Figure 4-2: Sequence for moving from a high power to low power state (RX110, RX111, RX113, RX130)

# 5. Appendices

# **5.1 Confirmed Operation Environment**

This section describes confirmed operation environment for the LPC FIT module.

Table 5.1 Confirmed Operation Environment (Rev. 1.41)

Item	Contents	
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.3.0	
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00.  Compiler option: The following option is added to the default settings of the integrated development environment.  -lang = c99	
Endian	Big endian/little endian	
Revision of the module	Rev.1.41	

**Table 5.2 Confirmed Operation Environment (Rev. 1.42)** 

Item	Contents	
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.5.0	
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00.  Compiler option: The following option is added to the default settings of the integrated development environment.  -lang = c99	
Endian	Big endian/little endian	
Revision of the module	Rev.1.42	
Board used	Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx)	

Table 5.3 Confirmed Operation Environment (Rev. 2.00)

Item	Contents	
Integrated development environment	Renesas Electronics e <sup>2</sup> studio Version 7.6.0	
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00.  Compiler option: The following option is added to the default settings of the integrated development environment.  -lang = c99	
	GCC for Renesas RX 4.8.4.201902 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99	
	IAR C/C++ Compiler for Renesas RX version 4.12.1  Compiler option: The default settings of the integrated development environment.	
Endian	Big endian/little endian	
Revision of the module	Rev.2.00	
Board used	Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx)	

Table 5.4 Confirmed Operation Environment (Rev. 2.01)

Item	Contents		
Integrated development	Renesas Electronics e <sup>2</sup> studio Version 7.7.0		
environment	IAR Embedded Workbench for Renesas 4.14.01		
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00.  Compiler option: The following option is added to the default settings of the integrated development environment.  -lang = c99		
	GCC for Renesas RX 8.3.0.201904		
	Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99		
	IAR C/C++ Compiler for Renesas RX version 4.14.1		
	Compiler option: The default settings of the integrated development environment.		
Endian	Big endian/little endian		
Revision of the module	Rev.2.01		
Board used	Renesas Starter Kit for RX130 (product No.: RTK5005130xxxxxxxx) Renesas Starter Kit for RX231 (product No.: R0K505231xxxxxx) Renesas Starter Kit+ for RX64M (product No.: R0K50564Mxxxxxx) Renesas Starter Kit+ for RX65N (product No.: RTK500565Nxxxxxxxx) Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx) Renesas Starter Kit+ for RX72N (product No.: RTK5572Nxxxxxxxxxxx)		

Table 5.5 Confirmed Operation Environment (Rev. 2.02)

Item	Contents		
Integrated development	Renesas Electronics e2 studio 2021-01		
environment	IAR Embedded Workbench for Renesas 4.20.01		
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00.  Compiler option: The following option is added to the default settings of the integrated development environment.  -lang = c99		
	GCC for Renesas RX 8.3.0.202004  Compiler option: The following option is added to the default settings of the integrated development environment.  -std=gnu99		
	IAR C/C++ Compiler for Renesas RX version 4.20.1 Compiler option: The default settings of the integrated development environment.		
Endian	Big endian/little endian		
Revision of the module	Rev.2.02		
Board used	Renesas Starter Kit+ for RX671 (product No.: RTK55671Exxxxxxxx)		

Table 5.6 Confirmed Operation Environment (Rev. 2.03)

Item	Contents		
Integrated development	Renesas Electronics e <sup>2</sup> studio Version 2021-07		
environment	IAR Embedded Workbench for Renesas 4.20.01		
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00.  Compiler option: The following option is added to the default settings of the		
	integrated development environment.		
	-lang = c99		
	GCC for Renesas RX 8.3.0.202102		
	Compiler option: The following option is added to the default settings of the		
	integrated development environment.		
	-std=gnu99		
	IAR C/C++ Compiler for Renesas RX version 4.20.1		
	Compiler option: The default settings of the integrated development		
	environment.		
Endian	Big endian/little endian		
Revision of the module	Rev.2.03		
Board used	Target board for RX140 (product No.:RTK5RX140xxxxxxxxxx)		

# 5.2 Troubleshooting

(1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".

A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:

Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

Using e<sup>2</sup> studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using this FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

(2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r\_lpc\_rx module.

A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.

# **Revision History**

		ion	
Rev.	Date	Page	Summary
1.40	Oct. 01, 2016	-	Initial release
1.41 Apr. 01, 2019	Apr. 01, 2019	-	Changes associated with functions:
			Added support setting function of configuration option Using
			GUI on Smart Configurator.
		[Description]	
		Added a setting file to support configuration option setting	
			function by GUI.
		1	Changed Related Document.
		4	Moved 1.1 LPC FIT Module.
			Changed 1.2 Overview of the LPC FIT Module.
		5	Moved 1.3 API Overview.
			Changed 1.4 State Transition Diagram.
		8	Deleted Hardware Resource Requirement.
			Deleted Limitations.
			Changed 2.3 Supported Toolchains.
			Added 2.4 Interrupt Vector.
			Changed 2.5 Header Files.
			Changed 2.6 Integer Types.
		9	Changed 2.7 Configuration Overview.
		10	Changed 2.8 Code Size.
		12	Changed 2.9 Parameters.
		13	Changed 2.10 Return Values.
		4.4	Added 2.11 Callback Function.
		14	Changed 2.12 Adding the FIT Module to Your Project.
		15	Added 2.13 "for", "while" and "do while" statements.
		25	Changed R_LPC_GetVersion.
		31	Added 5.5 Downloading Demo Projects.
		32	Added 6.1 Confirmed Operation Environment.
		33	Added 6.2 Troubleshooting.
1.42	Jul. 01, 2019	-	Added support for RX23W.
		23	Added RX230 to the description for
0.00	N: 44.0040		R_LPC_ReturnClockSwitch().
2.00	Nov. 14, 2019	-	Deleted RX210 from target device.
		1	Deleted "Related Documents".
		9	Supported the following compilers.
		26	- GCC for Renesas RX
		12	- IAR C/C++ Compiler for Renesas RX
		13	Deleted the section of Target devices describing "WAIT_LOOP"
		23	Corrected typographic error at the "Format" content of R_LPC_GetVersion ().
		26	Deleted the section of "Demo Projects".



		Description	on .
Rev.	Date	Page	Summary
2.01	Jun. 10, 2020	-	Added support for RX65N, RX66N, RX72M and RX72N.
		1	Added Target Compilers.
		7	Added revision of dependent r_bsp module in 2.2 Software
			Requirements.
		9	Changed 2.8 Code Size.
		12	Changed 2.12 Adding the FIT Module to Your Project.
		14-23	Deleted "Reentrant" for each API in 3 API Functions.
		27	Added Table 5.4 Confirmed Operation Environment (Rev.
			2.01).
		Program	Fixed the following.
			[Target device]
			All devices.
			[Description]
			Changed processing so that there is a register that may be
			accessed from multiple peripheral functions at the same time,
0.00	1 0 0001		and the atomicity of writing to that register can be ensured.
2.02	Apr. 2. 2021	-	Added support for RX671.
2.03	Jul. 31, 2021	-	Added support for RX140.
		1	Added target device for RX140.
		4	Added Operating Power Control modes for RX140 in 1.2
		4	Overview of the LPC FIT Module.
		4	Added Low Power Consumption modes for RX140 in 1.2 Overview of the LPC FIT Module.
		5	Added API function (R_LPC_ SnoozeModeConfigure) .
		8	Added the state transition diagram of the LPC FIT module of
			RX140 in 1.4 State Transition Diagram.
		9	Changed the revision of the dependent r_bsp module in 2.2
			Software Requirements.
		9	Added interrupt vector table for snooze mode in 2.4 Interrupt
			Vector.
		11	Changed 2.8 Code Size.
		12	Added R_LPC_OperatingModeSet Data Types for RX140 in
			2.9.1 R_LPC_OperatingModeSet Data Types.
		13	Added R_LPC_SnoozeModeConfigure Data Types for RX140
		4.4	in 2.9.4 R_LPC_ SnoozeModeConfigure Data Types.
		14	Added the description of Callback Function in 2.11 Callback
		24	Function.
		24	Added R_LPC_ SnoozeModeConfigure function.
		33	Added Table 5.6 Confirmed Operation Environment (Rev.
			2.03).

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

- 6. Voltage application waveform at input pin
  - Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).
- 7. Prohibition of access to reserved addresses
  - Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
- 8. Differences between products
  - Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

#### **Notice**

- 1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
- 2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
- 3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others
- 4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
- 5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
- 6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
  - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
  - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.

Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.

- 7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
- 8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
- 9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
- 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
- 12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
- 13. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
- 14. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
- (Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.
- (Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.5.0-1 October 2020)

### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

# **Trademarks**

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

#### Contact information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: <a href="https://www.renesas.com/contact/">www.renesas.com/contact/</a>.